G3VM-41PR11

MOS FET Relays

Smallest Class in market, USOP Package MOS FET Relays with Low Output Capacitance and ON Resistance ($CxR=5pF\cdot\Omega$)

• Dielectric strength of 500Vrms between I/O.



Note: The actual product is marked differently from the image shown here.

RoHS Compliant

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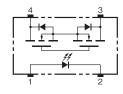
Refer to "Common Precautions".

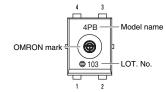
■Application Examples

- Semiconductor test equipment
- Communication equipment
- Test & measurement
- Data loggers

equipment

■Terminal Arrangement/Internal Connections





Note: The actual product is marked differently from the image shown here.

■List of Models

Package type	Contact form	Terminals	Load voltage (peak value) (See note.)	Model	Minimum package quantity Number per tape & reel
USOP4	_	Surface-mounting terminals		G3VM-41PR11	_
	1a (SPST-NO)		40V	G3VM-41PR11 (TR05)	500
	(6/ 6/ 146)			G3VM-41PR11 (TR)	1,500

- Note 1. Ask you OMRON representative for orders under 1,500 pcs or 500 pcs.
 - 2. Tape-cut USOPs are packaged without humidity resistance. Use manual soldering to mount them. Refer to common precautions.
 - 3. The AC peak and DC value is given for the load voltages

■Absolute Maximum Ratings (Ta = 25°C)

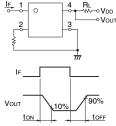
	Item	Symbol	Rating	Unit	Measurement conditions			
	LED forward current	lF	50	mA				
Ī	LED forward current reduction rate	ΔIF/°C	-0.5	mA/°C	Ta≥25°C			
Input	LED reverse voltage	VR	5	V				
	Connection temperature	TJ	125	°C				
Output	Load voltage (AC peak/DC)	Voff	40	V				
	Continuous load current (AC peak/DC)	lo	140	mA				
	ON current reduction rate	Δlo/°C	-1.4	mA°C	Ta≥25°C			
	Pulse ON current	lop	420	mA	t=100ms, Duty=1/10			
	Connection temperature	TJ	125	°C				
Dielectric strength between I/O (See note 1.)		V _{I-O}	500	Vrms	AC for 1 min			
An	nbient operating temperature	Ta	-40~+85	°C	With no icing or condensation			
An	nbient storage temperature	Tstg	-40~+125	°C	With no icing or condensation			
So	Idering temperature	-	260	°C	10s			

Note: 1.The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	VF	1.0	1.15	1.3	V	IF=10mA
	Reverse current	lr	-	-	10	μΑ	VR=5V
	Capacity between terminals	Ст	-	15	-	pF	V=0, f=1MHz
	Trigger LED forward current	İFT	-	1.0	3	mA	lo=100mA
Output	Maximum resistance with output ON	Ron	-	7	10	Ω	IF=5mA, Io=140mA, t<1s
	Current leakage when the relay is open	ILEAK	-	-	1	nA	Voff=40V
	Capacity between terminals	Coff	-	0.7	1.3	pF	V=0, f=100MHz, t<1s
Capacity between I/O terminals		C _I -o	-	0.4	-	pF	f=1MHz, Vs=0V
Insulation resistance between I/O terminals		Rı-o	1000	-	-	$M\Omega$	Vi-o=500VDC, RoH≤60%
Turn-ON time		ton	-	0.04	0.2	ms	Ir=5mA, RL=200Ω,
Turn-OFF time		toff	-	0.14	0.2	ms	V _{DD} =20V (See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



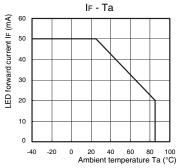
■Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

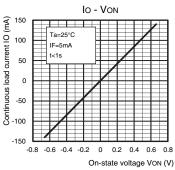
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	VDD	-	-	32	٧
Operating LED forward current	lF	5	7.5	20	mA
Continuous load current (AC peak/DC)	lo	_	-	140	mA
Ambient operating temperature	Ta	-20	-	65	°C

■Engineering Data

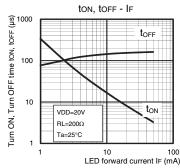
LED forward current vs. Ambient temperature



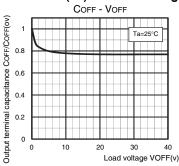
Continuous load current vs. On-state voltage



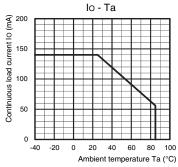
Turn ON, Turn OFF time vs. LED forward current



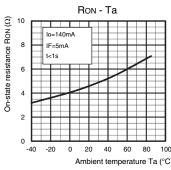
Output terminal capacitance COFF/COFF(ov) vs. Load voltage



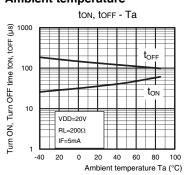
Continuous load current vs. Ambient temperature



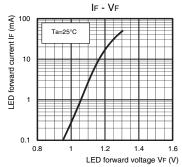
On-state resistance vs. Ambient temperature



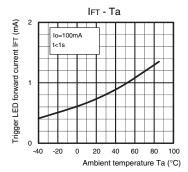
Turn ON, Turn OFF time vs. Ambient temperature



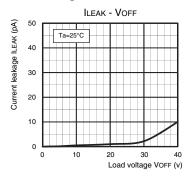
LED forward current vs. LED forward voltage



Trigger LED forward current vs. Ambient temperature



Current leakage vs. Load voltage



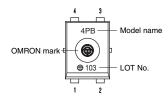
■Safety Precautions

•Refer to "Common Precautions" for all G3VM models.

■Appearance

USOP (Ultra Small Outline Package)

USOP4



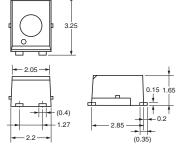
Note: The actual product is marked differently from the image shown here.

■Dimensions (Unit: mm)



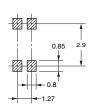
Surface-mounting Terminals

Weight: 0.03g



Actual Mounting Pad Dimensions

(Recommended Value, Top View)



Note: The actual product is marked differently from the image shown here.

Note: Do not use this document to operate the Unit.

Contact: www.omron.com/ecb

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
 Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

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